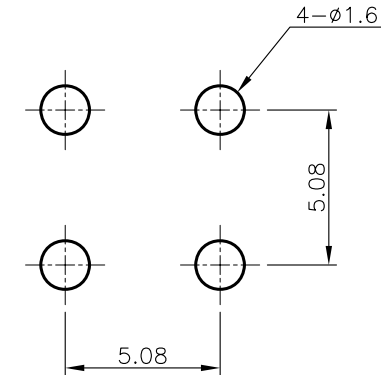
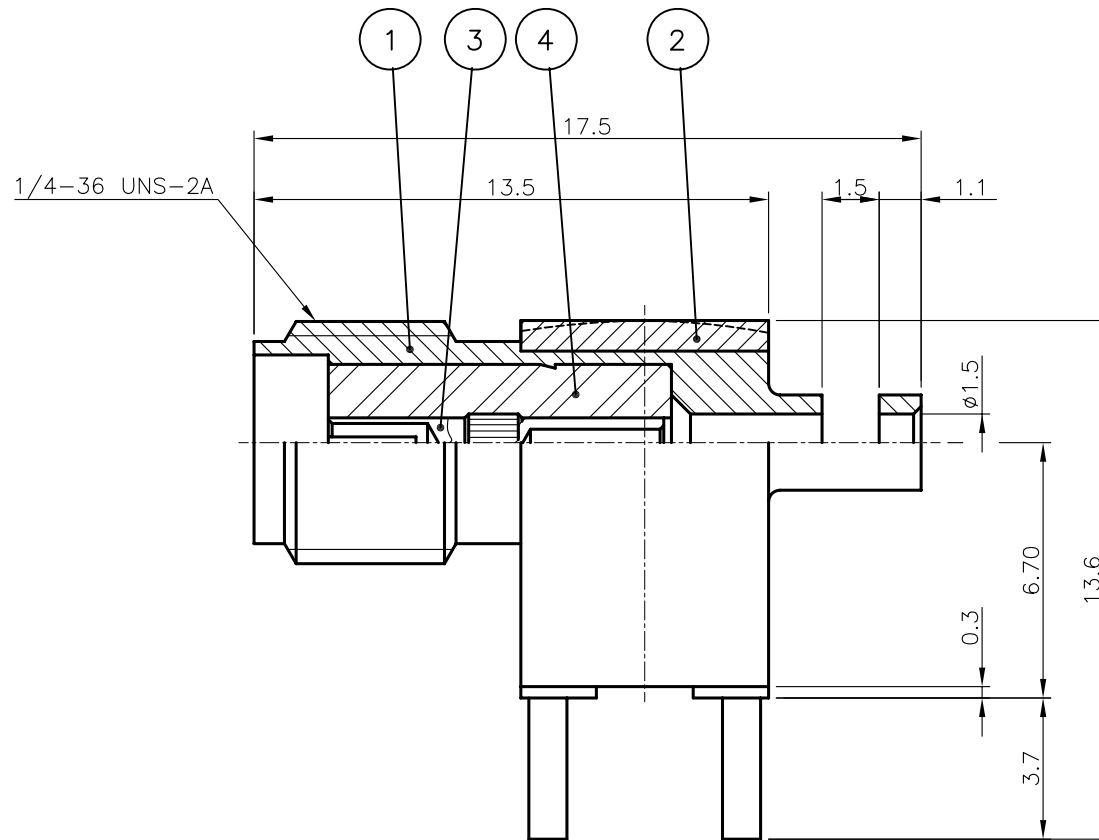
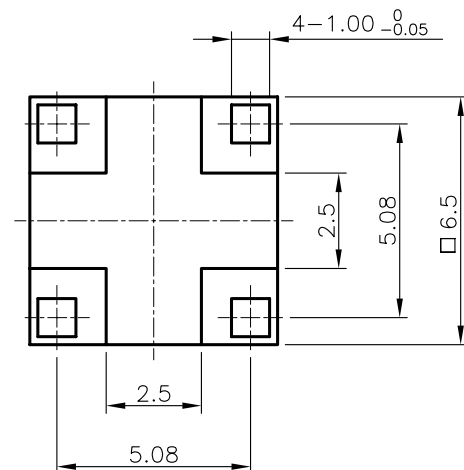


REV	DESCRIPTION	DRAWN	APPR	DATE
1R	Initial Registration	I.C.KIM	J.H.YOUN	2012.02.24.
1	[설번처리 No.201211-0006]CABLE 삽입 곤란으로 인한 TEFLON변경	E.H.KIM	I.C.KIM	2012.11.21.



PCB MOUNTING HOLE



1	4	INSULATOR	1	TEFLON		DIN02104-N/1 DIN00102-N/1
	3	CONTACT	1	BeCu	Gold Plate	DCT02556-5/1
	2	BODY (B)	1	MBsBD	Gold Plate	DBD03027-5/1
	1	BODY (A)	1	MBsBD	Gold Plate	DBD03026-5/1
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE			 KJ COMTECH CO.,LTD. RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
	±0.2	2012. 11. 21.					
	Angle	APPROVED BY	I.C.KIM		TITLE SMA50 CABLE JL-4R MCB/#54-1.33Φ		
±1°	CHECKED BY						
MATERIAL	_____	DRAWN BY	E.H.KIM		A4		
FINISH	_____	SCALE	UNIT				
		5/1	mm		DWG NO.	CN02770-7/1	
					REVISION	1	SHEET 1 of 1